

VMDSEMI

**VUSP002R380NA**

**Datasheet**

## General Description

## Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
20V	38mΩ@10V	4A
	50mΩ@4.5V	
	80mΩ@2.5V	

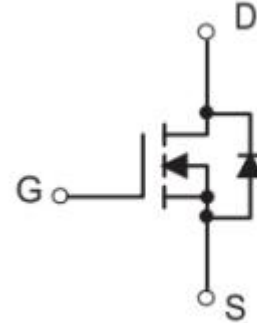
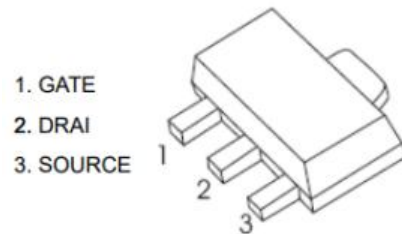


Figure 1 Symbol of VUSP002R380NA

## Features

- Excellent  $R_{DS(on)}$  and Low Gate Charge
- Trench FET Power MOSFET
- Low Gate Resistance

## Package Type



## Application

- DC/DC Converter
- Load Switch

## SOT-89-3L

Figure 2 Package Type of VUSP002R380NA

## Ordering Information

Product Name	Package
VUSP002R380NA	SOT-89-3L

**Absolute Maximum Ratings** ( $T_A = 25\text{ °C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 12$	V
Continuous Drain Current <sup>Note1</sup>	$I_D$	4	A
Pulsed Drain Current <sup>Note2</sup>	$I_{DM}$	16	A
Total Power Dissipation <sup>Note4</sup>	$P_D$	0.48	W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note5</sup>	$R_{\theta JA}$		85		°C/W

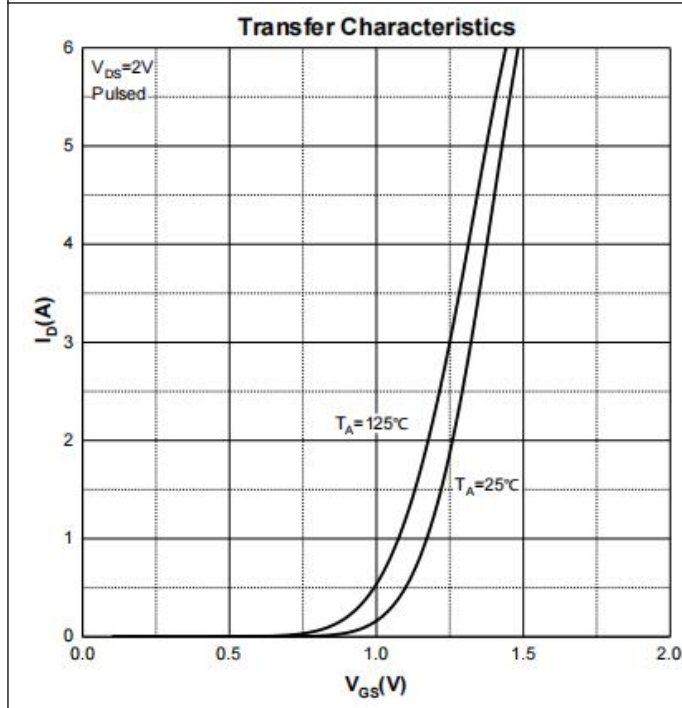
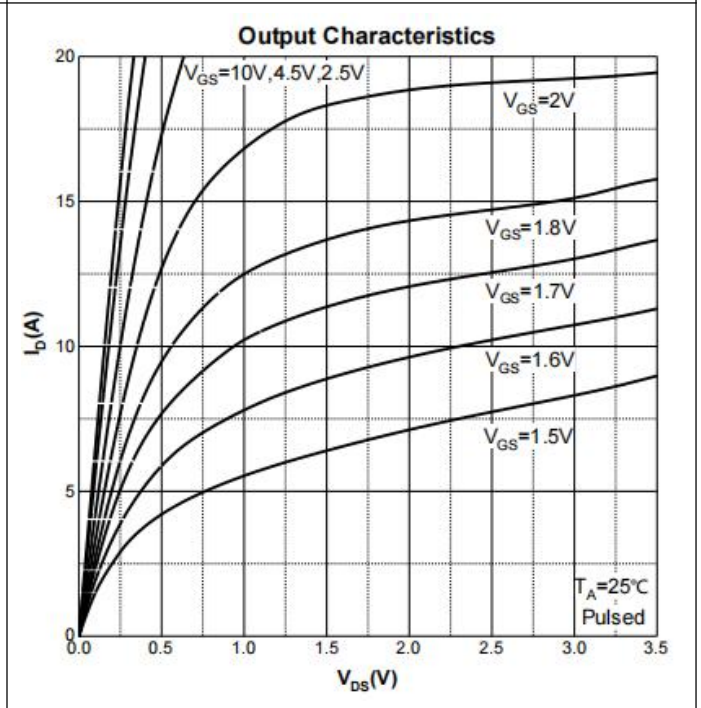
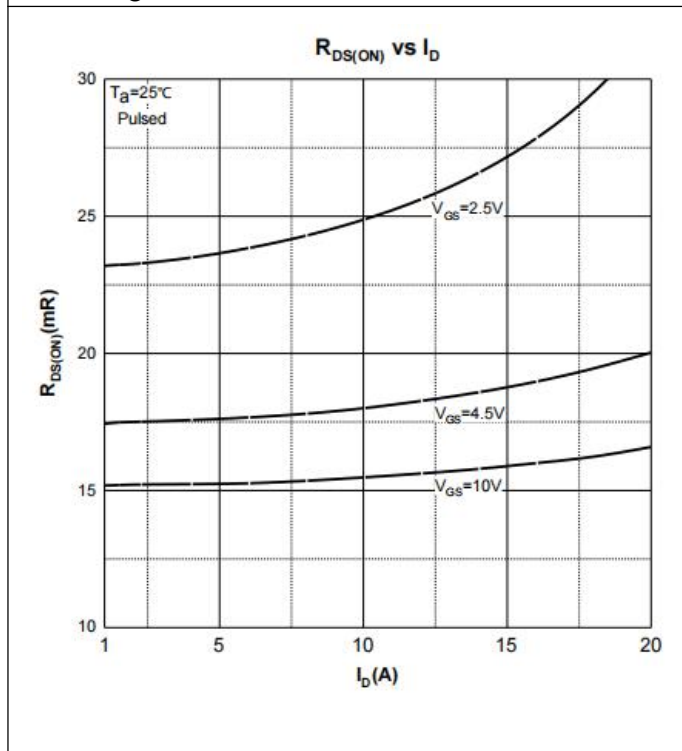
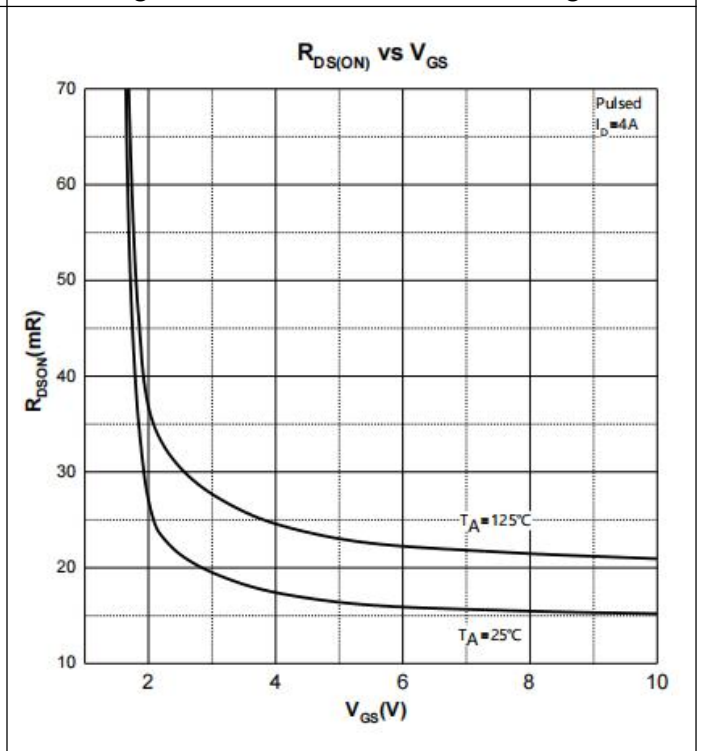
**Electrical Characteristics** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

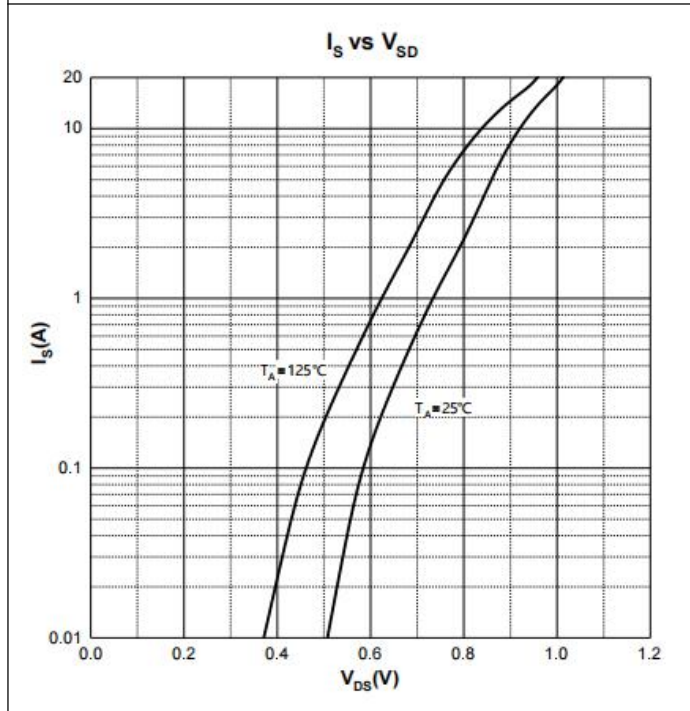
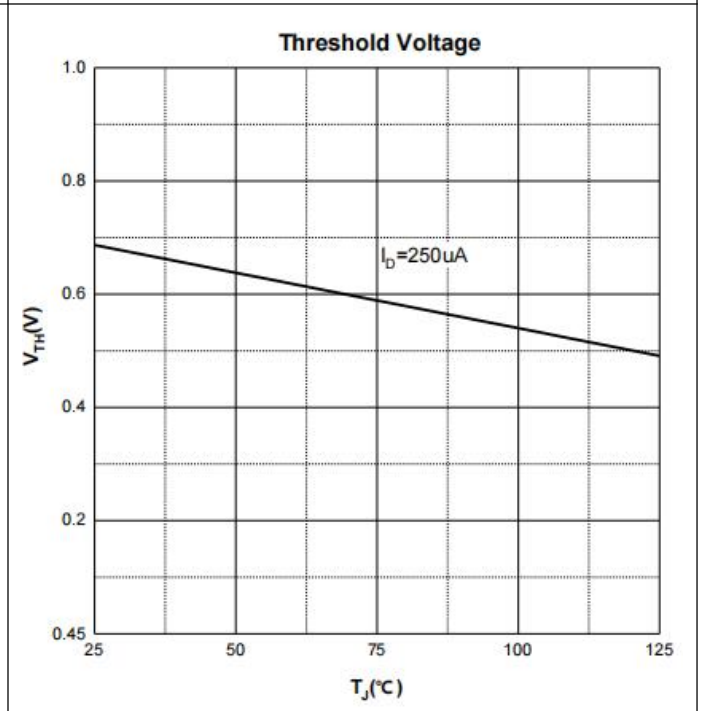
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=16V, V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS}=0V$			$\pm 100$	nA
Gate Threshold Voltage <sup>Note3</sup>	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4	0.65	1	V
Static Drain-Source On-Resistance <sup>Note3</sup>	$R_{DS(on)}$	$V_{GS}=10V, I_D=4A$		18	38	mΩ
		$V_{GS}=4.5V, I_D=3A$		20	50	
		$V_{GS}=2.5V, I_D=4A$		25	80	
Forward transconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=4.5V, I_D=4A$	3			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=10V$		336		pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$		78		pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$		70		pF
Total gate charge	$Q_g$	$V_{DS}=10V$		6		nC
Gate-source charge	$Q_{gs}$	$V_{GS}=4.5V$		1		nC
Gate-drain charge	$Q_{gd}$	$I_D=4A$		1.7		nC
Gate Resistance	$R_g$	$f=1MHz, \text{open drain}$		1.6		Ω
<b>Switching Parameters</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V$		4		ns
Turn-on Rise Time	$t_r$	$V_{GEN}=4.5V$		15		
Turn-off Delay Time	$t_{d(off)}$	$R_L=2.5\Omega$		20		
Turn-off Fall Time	$t_f$	$R_{GEN}=3\Omega$		25		
<b>Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$V_{SD}$	$V_{GS}=0V, I_S=4A$			1.2	V

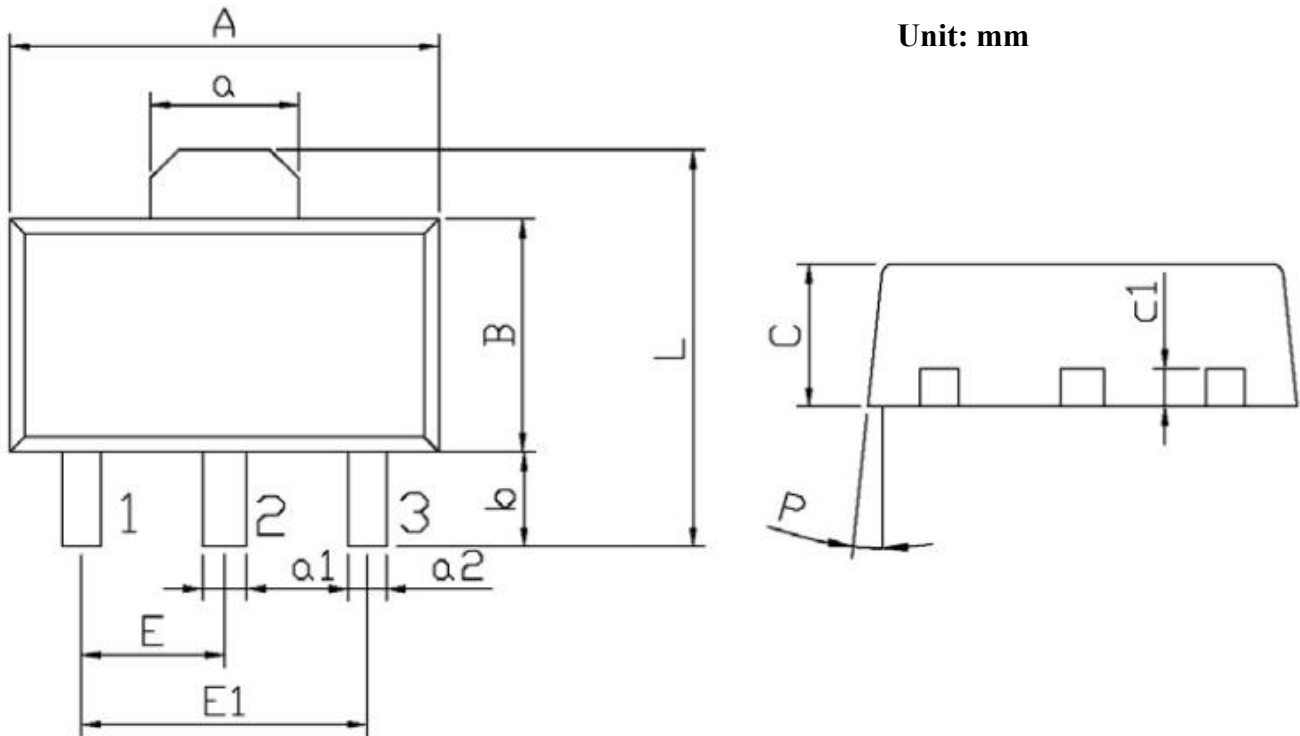
Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ C$ .
- 5.Device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ .

## Typical Performance Characteristics

**Figure 3: Transfer Characteristics**

**Figure 4: Output Characteristics**

**Figure 5: On-Resistance vs. Drain Current**

**Figure 6: On-Resistance vs. Gate Voltage**


**Figure 7: Body Diode Characteristics**

**Figure 8: Threshold Voltage**


**Mechanical Dimensions:**
**SOT-89-3L Package Information**

**Unit: mm**

Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
A	4.4	4.7	a1	0.36	0.56
B	2.35	2.65	a2	0.30	0.50
L	3.878	4.478	C	1.40	1.70
a	1.45	1.65	c1	0.35	0.50
E	1.40	1.60	P	6°	
E1	2.80	3.20			
b	0.80	1.20			

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## Via-Media Semiconductor Limited Company

<http://www.vmdsemi.com>

### Main Sites:

#### - Headquarters

Hangzhou Via-Media Semiconductor Co., LTD.  
1305-1306, Building 71, No. 90, Wensan Road, Xihu  
District, Hangzhou, Zhejiang Province, P.R. China  
Tel: +86-0571-8515 0563

#### - Shanghai

Shanghai R&D Center.  
1506~1508, Xinyin Building, 888 Yishan Road,  
Shanghai, P.R of China  
Tel: +86- 021-54201999

#### - Xi'an

Xi'an R&D Center  
1703B, Building A, Greenland Center, Jinye Road,  
High-Tech Zone, Xi'an, Shaanxi, P.R of China

#### - Chengdu Office

Chengdu Winhi Semiconductor Co., LTD.  
Floor 15, Building 5, No. 171, Hele 2<sup>nd</sup> Street,  
Chengdu, Sichuan Province, P.R. China  
Tel: +86-028-8505 0771

#### - Shenzhen

Shenzhen Sales Center.  
17B, No.1 Phoenix Building, 2008 Shennan Road,  
Shenzhen, P.R of China  
Tel: +86-0755- 82570682